AUTOMOTIVE

RoHS COMPLIANT

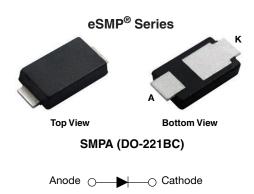
HALOGEN

FREE



## Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	4.0 A			
V <sub>RRM</sub>	45 V			
I <sub>FSM</sub>	80 A			
$V_F$ at $I_F = 4.0$ A $(T_A = 125  ^{\circ}C)$	0.41 V			
T <sub>J</sub> max.	150 °C			
Package	SMPA (DO-221BC)			
Circuit configuration	Single			

#### **FEATURES**

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

#### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### **MECHANICAL DATA**

Case: SMPA (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V4PAL45	UNIT	
Device marking code		4L45		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	45	V	
Maximum DC forward current	I <sub>F</sub> <sup>(1)</sup>	4.0	Α	
Maximum DC forward current	I <sub>F</sub> <sup>(2)</sup>	3.0		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	80	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

#### Notes

- (1) Units mounted on 15 mm x 15 mm pad areas, 2 oz. PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 2.0 A	T. − 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.43	-	V
	I <sub>F</sub> = 4.0 A			0.49	0.57	
	I <sub>F</sub> = 2.0 A	T <sub>A</sub> = 125 °C		0.33	-	
	I <sub>F</sub> = 4.0 A			0.41	0.50	
Reverse current	V <sub>R</sub> = 45 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	450	μΑ
Reverse current	$V_R = 45 \text{ V}$ $T_A = 125 \text{ °C}$	T <sub>A</sub> = 125 °C		5	15	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	450	_	pF

#### Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width  $\leq 5 \text{ ms}$ 

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise specified)				
PARAMETER SYMBOL V4PAL45			UNIT	
Typical thermal resistance	R <sub>0JA</sub> (1)	100	°C/W	
	R <sub>0JM</sub> (1)	9	C/ VV	

#### Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V4PAL45-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
V4PAL45HM3_A/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

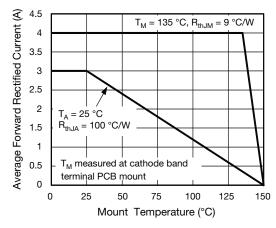


Fig. 1 - Maximum Forward Current Derating Curve

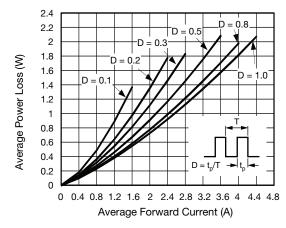


Fig. 2 - Forward Power Loss Characteristics



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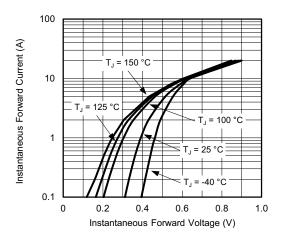


Fig. 3 - Typical Instantaneous Forward Characteristics

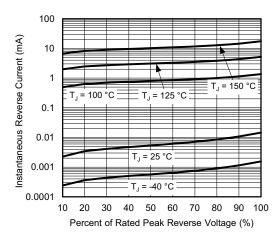


Fig. 4 - Typical Reverse Leakage Characteristics

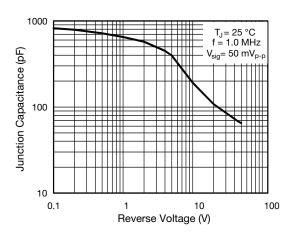


Fig. 5 - Typical Junction Capacitance

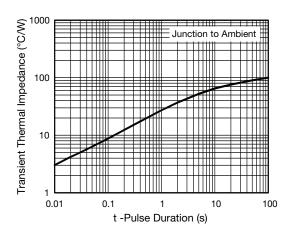


Fig. 6 - Typical Transient Thermal Impedance

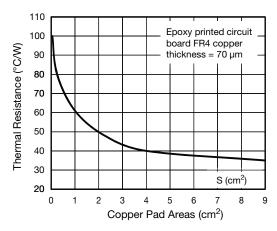


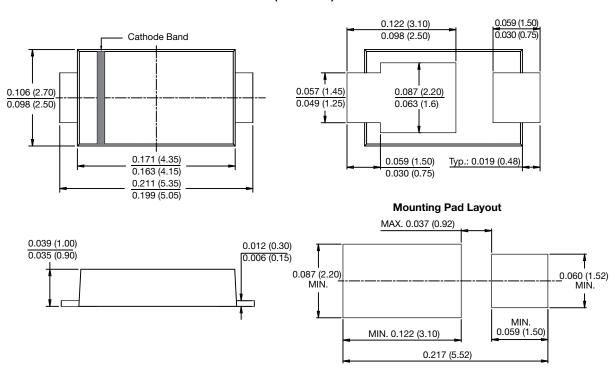
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### **SMPA (DO-221BC)**





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